

INFORMATION DISCLOSURE STATEMENT

Applicant : Hayashi et al.
App. No : 10/565,696
Filed : January 24, 2006
For : RESIN FOR RESIST, POSITIVE
RESIST COMPOSITION, AND
METHOD OF FORMING RESIST
PATTERN
Examiner : Huhn, Richard A.
Art Unit : 1796

Mail Stop Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:

Enclosed for filing in the above-identified application is a PTO/SB/08 Equivalent listing 1 (one) references to be considered by the Examiner.

This Information Disclosure Statement is being filed before the mailing date of a final action and before the mailing date of a Notice of Allowance. Thus, no fee is required as set forth in 37 C.F.R. § 1.97(c), however, the Commissioner is hereby authorized to charge any additional fees which may be required or to credit any overpayment to Account No. 11-1410.

CERTIFICATION UNDER 37 C.F.R. § 1.97(e)(2)

I hereby certify that no item of information contained in this Statement was cited in a communication from a foreign Patent Office in a counterpart foreign application, and, to my

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Docket No. SHIGA7.043APC
Customer No. 20,995

knowledge after making reasonable inquiry, was known to any individual designated in 37 C.F.R.
§ 1.56(c) more than 3 months prior to the filing of this Information Disclosure Statement.

Respectfully submitted,

KNOBBE, MARTENS, OLSON & BEAR, LLP

Dated: 8/10/09

By: 

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